CONSTRUCTION Examination Examination Examination Examination Examination According to the drawing. > ELECTRICAL CHARACTERISTICS Contact Resistance Measured at DC 1A. Is mCLMAX. > Resistance to soldering heat Solder temperature, +380±10°C, for immersion duration, 5°, 9. No deformation of case of excessive to solder temperature, +350±10°C for immersion duration, 5°, 9. No deformation of case of excessive to solder temperature, +350±10°C for immersion duration, 400 error prin-hole, no duration, 2°, 9. Solder sufface to be free from prin-hole, no wetting and other defects. Solderability Solderability Solder sufface temperature, +350±10°C for immersion duration, error prin-hole, no duration, 2°, 9. Solder sufface to be free from prin-hole, no wetting and other defects. COUNT DESCRIPTION OF REVISIONS DESIGNED CHECKED C REMARK REMARK APPROVED YH, YMM0A 20 Notes (1)The applicable cable should satisfy both conditions (1) and (2). SH ROYMAA 20	APF	PLICA	BLE STAN	DARD							
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